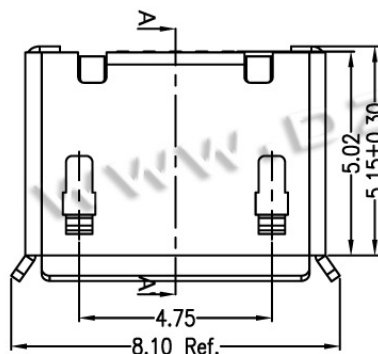
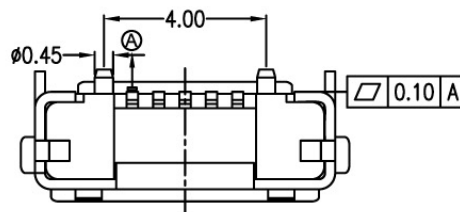
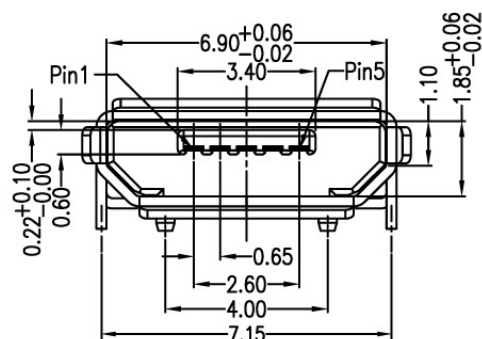


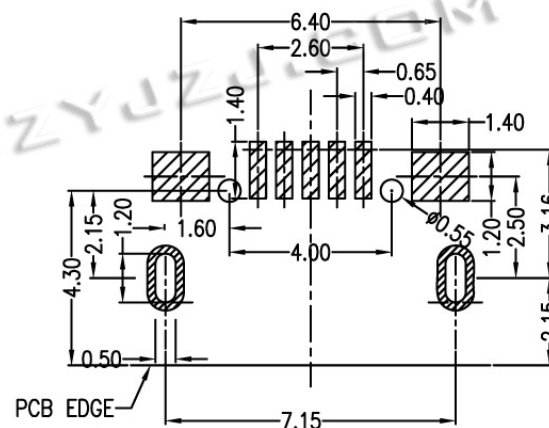
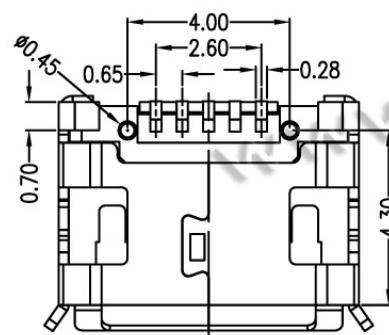
Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 KgF Max.
- 2.6 Total unmating force: 1.0 KgF Min.
- 2.7 Temperature range: -30°C~80°C



RECOMMENDED PCB LAYOUT

PCB图仅供参考



深圳市华宇创精密电子有限公司

TOLERANCE:

X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X' ±2° X.X' ±0.5°

UNIT: mm [inch]

SCALE:1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

MICRO USB 5P 7.15 加固有柱 有卷边

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

HYC273-USBD05-715

APPROVED BY:

邱敏

DATE :

2014-02-23

DRAW NO:

HYC-USB200603174

SHEET NO.

1 OF 1